

SMALL SIGNAL SCHOTTKY DIODE

DESCRIPTION

Metal to silicon junction diode primarily intended for UHF mixers and ultrafast switching applications.


MINIMELF
 (Glass)

ABSOLUTE RATINGS (limiting values)

Symbol	Parameter	Value	Unit
V_{RRM}	Repetitive Peak Reverse Voltage	4	V
I_F	Forward Continuous Current	30	mA
I_{FSM}	Surge non Repetitive Forward Current	60	mA
T_{sig} T_J	Storage and Junction Temperature Range	- 65 to 150 125	°C °C
T_L	Maximum Temperature for Soldering during 15s	260	°C

THERMAL RESISTANCE

Symbol	Parameter	Value	Unit
$R_{th} (J-L)$	Junction-leads	400	°C/W

ELECTRICAL CHARACTERISTICS
STATIC CHARACTERISTICS

Symbol	Test Conditions		Min.	Typ.	Max.	Unit
$V_{(BR)}$	$T_{amb} = 25^\circ C$	$I_R = 10\mu A$	4			V
$V_F (1)$	$T_{amb} = 25^\circ C$	$I_F = 10mA$			0.6	V
$I_R (1)$	$T_{amb} = 25^\circ C$	$V_R = 3V$			0.25	μA

DYNAMIC CHARACTERISTICS

Symbol	Test Conditions			Min.	Typ.	Max.	Unit
C	$T_{amb} = 25^\circ C$	$V_R = 1V$	$f = 1MHz$			1	pF
F (2)	$T_{amb} = 25^\circ C$		$f = 1GHz$		6		dB

(1) Pulse test : $t_b \leq 300\mu s$ $\delta < 2\%$

(2) Noise figure test :

- diode is inserted in a tuned stripline circuit
- local oscillator frequency 1GHz
- local oscillator power 1mW
- intermediate frequency amplifier, tuned on 30MHz, has a noise figure 1.5dB.

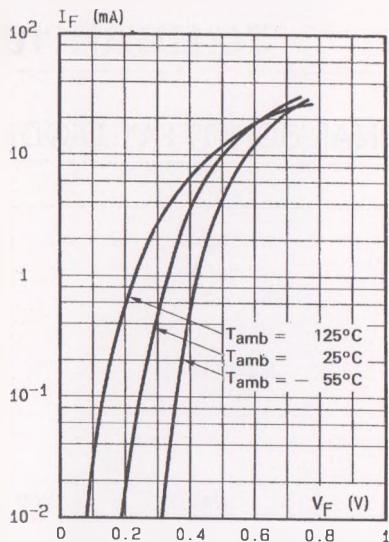


Fig.1 - Forward current versus forward voltage (typical values).

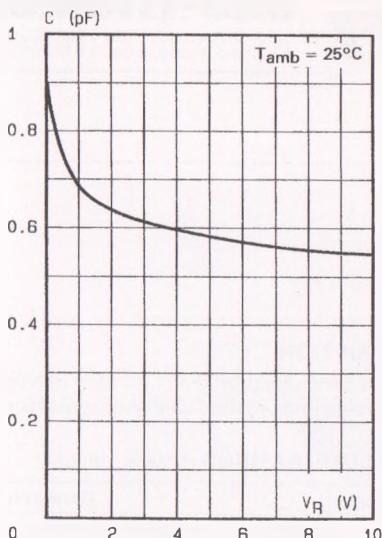


Fig.2 - Capacitance C versus reverse applied voltage V_R (typical values).

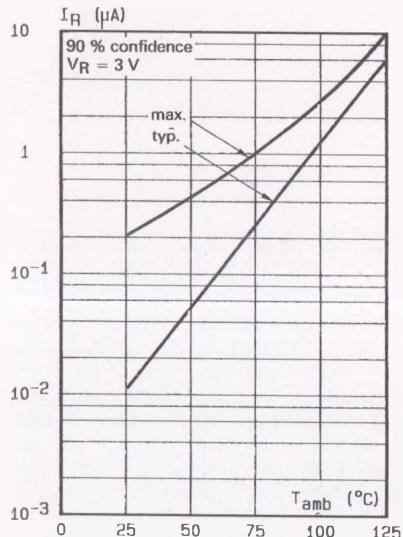


Fig.3 - Reverse current versus ambient temperature.

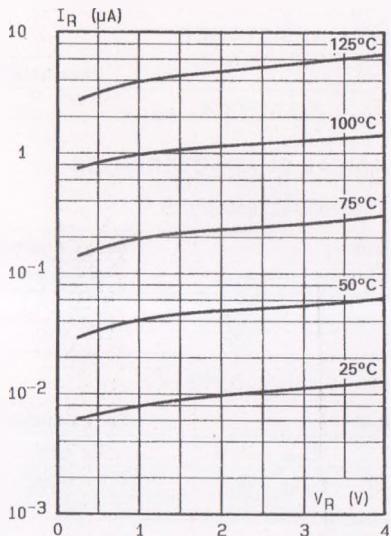


Fig.4 - Reverse current versus continuous reverse voltage (typical values).